

Micropower Phase-Locked Loop

Features

- Wide supply voltage range: 3.0V to 18V
- Low dynamic: 70µW (typ.) at power consumption: fo = 10 kHz, V_{DD} = 5V
- VCO frequency: 1.3 MHz (typ.) at V_{DD} = 10V
- Low frequency drift: 0.06%/°C at V_{DD} = 10V with temperature
- High VCO linearity: 1% (typ.)



Ordering Information

DEVICE	Package Type	MARKING	Packing	Packing Qty
CD4046BE	DIP-16	CD4046BE	TUBE	1000pcs/box
CD4046BM/TR	SOP-16	CD4046B	REEL	2500pcs/reel
CD4046BMT/TR	TSSOP-16	CD4046B	REEL	2500pcs/reel



General Description

The CD4046B micropower phase-locked loop (PLL) consists of a low power, linear, voltage-controlled oscillator (VCO), a source follower, a zener diode, and two phase comparators. The two phase comparators have a common signal input and a common comparator input. The signal input can be directly coupled for a large voltage signal, or capacitively coupled to the self-biasing amplifier at the signal input for a small voltage signal.Phase comparator I, an exclusive OR gate, provides a digital error signal (phase comp. I Out) and maintains 90° phase shifts at the VCO center frequency. Between signal input and comparator input (both at 50% duty cycle), it may lock onto the signal input frequencies that are close to harmonics of the VCO center frequency.Phase comparator II is an edge-controlled digital memory network. It provides a digital error signal (phase comp. II Out) and lock-in signal (phase pulses) to indicate a locked condition and maintains a 0° phase shift between signal input and comparator input.

The linear voltage-controlled oscillator (VCO) produces an output signal (VCO Out) whose frequency is determined by the voltage at the VCO_{IN} input, and the capacitor and resistors connected to pin C1_A, C1_B, R1 and R2.The source follower output of the VCO_{IN} (demodulator Out) is used with an external resistor of 10 k Ω or more. The INHIBIT input, when high, disables the VCO and source follower to minimize standby power consumption. The zener diode is provided for power supply regulation, if necessary.

Applications

FM demodulator and modulator Frequency synthesis and multiplication Frequency discrimination Data synchronization and conditioning Voltage-to-frequency conversion Tone decoding FSK modulation Motor speed control



Block & Connection Diagrams



FIGURE 1

Dual-In-Line Package



Order Number CD4046B



Absolute Maximum Ratings (Notes 1 & 2)

If Military/Aerospace specified devices are required, please contact the National Semiconductor Sales Office/Distributors for availability and specifications.

Condition	Min	Мах	UNITS
DC Supply Voltage (V _{DD})	-0.5	+18	V _{DC}
Input Voltage (V _{IN})	-0.5	+0.5	V _{DC}
Storage Temperature Range (T _S)	-65	150	°C
Power Dissipation (P _D)	-	-	-
Dual-In-Line	-	700	mW
Small Outline	-	500	mW
Lead Temperature (T _L)	-	-	-
(Soldering, 10 seconds)	-	260	°C

Recommended Operating Conditions (Note 2)

Condition	Min	Max	UNITS
DC Supply Voltage (V _{DD})	+3	+15	VDC
Input Voltage (V _{IN})	0 to V _D	d Vdc	-
Operating Temperature Range (T _A)	-40	+85	°C



DC Electrical Characteristics (Note 2)

			-40	°C	+25°C			+85°C		
Symbol	mboi Parameter Conditions		Min	Max	Min	Тур	Max	Min	Мах	Units
		Pin 5 = V_{DD} , Pin 14 = V_{DD} ,								
		Pin 3, 9 = V _{SS}								
		V _{DD} = 5V		20		0.005	20		150	μA
	V _{DD} = 10V		40		0.01	40		300	μA	
	Ouissent Daviss Ourset	V _{DD} = 15V		80		0.015	80		600	μA
IDD		Pin 5 = V _{DD} , Pin 14 = Open,								
		Pin 3, 9 = V _{SS}								
		V _{DD} = 5V		70		5	55		205	μA
		V _{DD} = 10V		530		20	410		710	μA
		V _{DD} = 15V		1500		50	1200		1800	μA
		V _{DD} = 5V		0.05		0	0.05		0.05	V
V _{OL}	Low Level Output Voltage	V _{DD} = 10V		0.05		0	0.05		0.05	V
		V _{DD} = 15V		0.05		0	0.05		0.05	V
		V _{DD} = 5V	4.95		4.95	5		4.95		V
V _{OH} High Level Output Voltag	High Level Output Voltage	V _{DD} = 10V	9.95		9.95	10		9.95		V
		V _{DD} = 15V	14.95		14.95	15		14.95		V
		V_{DD} = 5V, V_{O} = 0.5V or 4.5V		1.5		2.25	1.5		1.5	V
	Comparator and Signal In	V_{DD} = 10V, V_O = 1V or 9V		3.0		4.5	3.0		3.0	V
		V _{DD} = 15V, V _O = 1.5V or 13.5V		4.0		6.25	4.0		4.0	V
		V_{DD} = 5V, V_{O} = 0.5V or 4.5V	3.5		3.5	2.75		3.5		V
VIH		V_{DD} = 10V, V_{O} = 1V or 9V	7.0		7.0	5.5		7.0		V
		V _{DD} = 15V, V _O = 1.5V or 13.5V	11.0		11.0	8.25		11.0		V
	Low Lovel Output Current	$V_{DD} = 5V, V_{O} = 0.4V$	0.52		0.44	0.88		0.36		mA
IOL	(Note 4)	V_{DD} = 10V, V_{O} = 0.5V	1.3		1.1	2.25		0.9		mA
		V _{DD} = 15V, V _O = 1.5V	3.6		3.0	8.8		2.4		mA
	High Lovel Output Current	V _{DD} = 5V, V _O = 4.6V	-0.52		-0.44	-0.88		-0.36		mA
Іон		V _{DD} = 10V, V _O = 9.5V	-1.3		-1.1	-2.25		-0.9		mA
		V _{DD} = 15V, V _O = 13.5V	-3.6		-3.0	-8.8		-2.4		mA
		All Inputs Except Signal Input								
I _{IN}	Input Current	V _{DD} = 15V, V _{IN} = 0V		-0.3		- 10 ⁻⁵	-0.3		-1.0	μA
		V _{DD} = 15V, V _{IN} = 15V		0.3		10-5	0.3		1.0	μA
CIN	Input Capacitance	Any Input (Note 3)					7.5			pF
		fo = 10 kHz, R1 = 1 MΩ								
		R2 = ∞ , VCO _{IN} = V _{DD} /2								
Pτ	Total Power Dissipation	V _{DD} = 5V				0.07				mW
		V _{DD} = 10V				0.6				mW
		V _{DD} = 15V				2.4				mW

Note 1: "Absolute Maximum Ratings" are those values beyond which the safety of the device cannot be guaranteed. They are not meant to imply that the devices should be operated at these limits. The table of "Recommended Operating Conditions" and "Electrical Characteristics" provides conditions for actual device operation.

Note 2: V_{SS} e 0V unless otherwise specified.

Note 3: Capacitance is guaranteed by periodic testing.

Note 4: I_{OH} and I_{OL} are tested one output at a time.



AC Electrical Characteristics* TA = 25°C, CL = 50 pF

Symbol	Parameter	Conditions	Тур	Max	Units	
		VCO SECTION				
		fo = 10 kHz, R1 = 1 MΩ				
		$R2 = \infty$, $VCO_{IN} = V_{DD}/2$				
IDD	Operating Current	V _{DD} = 5V		20		μA
		V _{DD} = 10V		90		μA
		V _{DD} = 15V		200		μA
		C1 = 50 pF, R1 = 10 kΩ,				
		$R2 = \infty$, $VCO_{IN} = V_{DD}$				
	Maximum Operating Frequency	V _{DD} = 5V	0.4	0.8		MHz
······································	V _{DD} = 10V	0.6	1.2		MHz	
		V _{DD} = 15V	1.0	1.6		MHz
		$VCO_{IN} = 2.5V \pm 0.3V,$				
		R1 ≥ 10 kΩ, V _{DD} = 5V		1		%
		VCOIN = 5V ± 2.5V,				
		R1 ≥ 400 kΩ, V _{DD} = 10V		1		%
f _{MAX}		$VCO_{IN} = 7.5V \pm 5V,$				
		R1 ≥ 1 MX, V _{DD} = 15V		1		%
		%/°C∞1/f. V _{DD}				
		R2 = ∞				
	Temperature-Frequency Stability No	V _{DD} = 5V		0.12 - 0.24		%/ °C
	Frequency Offset, f _{MIN} = 0	V _{DD} = 10V		0.04 - 0.08		%/ °C
		V _{DD} = 15V		0.015 - 0.03		%/ °C
		V _{DD} = 5V		0.06 - 0.12		%/ °C
	Frequency Offset, $f_{MIN} \neq 0$	V _{DD} = 10V		0.05 - 0.1		%/ °C
		V _{DD} = 15V		0.03 - 0.06		%/ °C
		V _{DD} = 5V		10 ⁶		MΩ
VCOIN	Input Resistance	V _{DD} = 10V		10 ⁶		MΩ
		V _{DD} = 15V		10 ⁶		MΩ
		V _{DD} = 5V		50		%
vco	Output Duty Cycle	V _{DD} = 10V		50		%
		V _{DD} = 15V		50		%
		V _{DD} = 5V		90	200	ns
	VCO Output Transition Time	V _{DD} = 10V		50	100	ns
t _{THL}		V _{DD} = 15V		45	80	ns

*AC Parameters are guaranteed by DC correlated testing.



AC Electrical Characteristics* TA e 25°C, CL = 50 pF (Continued)

Symbol	Parameter	Parameter Conditions						
PHASE COMPARATORS SECTION								
	Input Resistance							
	Signal Input	V _{DD} = 5V	1	3		MΩ		
		V _{DD} = 10V	0.2	0.7		MΩ		
		V _{DD} = 15V	0.1	0.3		MΩ		
	Comparator Input	V _{DD} = 5V		106		MΩ		
Б		V _{DD} = 10V		106		MΩ		
RIN		V _{DD} = 15V		106		MΩ		
		CSERIES = 1000 pF						
		f = 50 kHz						
	AC-Coupled Signal Input Voltage	V _{DD} = 5V		200	400	mV		
	Sensitivity	V _{DD} = 10V		400	800	mV		
		V _{DD} = 15V		700	1400	mV		
		DEMODULATOR OUTPUT						
		RS ≥ 10 kΩ, V _{DD} = 5V		1.50	2.2	V		
	Offset Voltage	RS ≥ 10 kΩ, V _{DD} = 10V		1.50	2.2	V		
NGO		RS ≥ 50 kΩ, V _{DD} = 15V		1.50	2.2	V		
		RS ≥ 50 kΩ						
	Linconity	$VCO_{IN} = 2.5V \pm 0.3V, V_{DD} = 5V$		0.1		%		
	Linearity	$VCO_{IN} = 5V \pm 2.5V, V_{DD} = 10V$		0.6		%		
		VCO _{IN} = 7.5V±5V, V _{DD} = 15V		0.8		%		
		ZENER DIODE						
Vz	Zener Diode Voltage	I _z = 50 μA	6.3	7.0	7.7	V		
Rz	Zener Dynamic Resistance	Iz = 1 mA		100		Ω		

*AC Parameters are guaranteed by DC correlated testing.



Phase Comparator State Diagrams



FIGURE 2

Typical Waveforms





Typical Performance Characteristics



Note: To obtain approximate total power dissipation of PLL system for no-signal input: Phase Comparator I, PD (Total) - PD (fo) + PD (fMIN) + PD (RS); Phas - Comparator II, PD (Total) - PD (fMIN).



Typical Performance Characteristics (Continued)



Note: To obtain approximate total power dissipation of PLL system for no-signal input: Phase Comparator I, PD (Total) - PD (fo) + PD (fMIN) + PD (RS); Phase Comparator II, P_D (Total) - PD (fMIN).



Design Information

This information is a guide for approximating the value of external components for the CD4046B in a phase-lockedloop system. The selected external components must be within the following ranges: R1, R2 \ge 10 k Ω , RS \ge 10 k Ω , C1 \ge 50 pF. In addition to the given design information, refer to Figure 5 for R1, R2 and C1 component selections.

	Using Phase	e Comparator I	Using Phase	Comparator II
Characteristics	VCO Without Offset R2= ⁰⁰	VCO With Offset	VCO Without Offset R2= ^{CO}	VCO With Offset
VCO Frequency	MAX fo fMIN VD/2 VD/2 VD VD VD VD VD VD VD VD VD VD			
For No Signal Input	VCO in PLL s to center f	ystem will adjust requency, fo	VCO in PLL sys lowest operating	tem will adjust to g frequency, fmin
Frequency Lock Range, 2 fL		2 fL = full VCO frequency	/ range 2 fL = fmax - fmin	
Frequency Capture Range, 2 fC		$2fc \approx \frac{1}{\pi} \sqrt{\frac{2\pi fL}{\pi 1}}$	fC	= fL
Loop Filter Component Selection		For 2 fC, see Ref.		
Phase Angle Between	90° at center freque	ncy (fo), approximating	Always	0° in lock
Locks on Harmonics of		/es	1	٧o
Signal Input Noise Rejection	F	ligh	L	w
VCO Component	Given: fo.	Given: fo and fL.	Given: fmax.	Given: fmin and fmax
Selection	Use fo with Figure 5a to	Calculate fmin	Calculate fo from the	Use fmin with
	determine R1 and C1.	from the equation	equation	Figure 5b to
		Use fmin with Figure 5b to determine R2 and C1. Calculate $\frac{fmax}{fmin}$ from the equation $\frac{fmax}{fmin} = \frac{fo + fL.}{fo - fL}$ Use $\frac{fmax}{fmin}$ with Figure 5c to determine ratio R2/ R1 to	Fo $=\frac{1112x}{2}$ Use fo with Figure 5a to determine R1 and C1.	Determine $\frac{\text{IIIIAX}}{\text{fmin}}$ Use $\frac{\text{fmax}}{\text{fmin}}$ with Figure 5c to determine ration R2/R1 to obtain R1.
		obtain R1.		



Physical Dimensions

DIP16





Dimensions In Millimeters(DIP16)												
Symbol:	А	В	D	D1	E	L	L1	а	b	с	d	
Min:	6.10	18.94	8.40	7.42	3.10	0.50	300	1.50	0.85	0.40	254 890	
Max:	6.68	19.56	9.00	7.82	3.55	0.70	3.60	1.55	0.90	0.50	2.04 830	

SOP16



Dimensions In Millimeters(SOP16)												
Symbol:	A	A1	В	С	C1	D	Q	а	b			
Min:	1.35	0.05	9.80	5.80	3.80	0.40	0°	0.35	1 07 000			
Max:	1.55	0.20	10.0	6.20	4.00	0.80	8°	0.45	1.27 650			



Physical Dimensions

TSSOP16



Dimensions In Millimeters(TSSOP16)											
Symbol:	A	A1	В	С	C1	D	Q	а	b		
Min:	0.85	0.05	4.90	6.20	4.30	0.40	0°	0.20			
Max:	0.95	0.20	5.10	6.60	4.50	0.80	8°	0.25	0.05 650		



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